

SCE600N1200MA3

1200V, 600A, 2.7mΩ, Half-Bridge, Silicon Carbide MOSFET Module



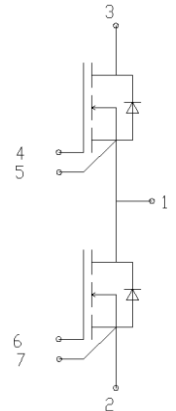
Product Data Sheet

General Description

The SCE-MA3 module incorporates SCE's 1200V Gen3 N-channel SiC MOSFET.

Features

- Industry Standard 62mm Footprint
- Ultra Low Loss, High-frequency Operation
- Zero Reverse Recovery from Diodes
- Zero Turn-off Tail Current from MOSFET
- Normally-off, Fail-safe Device Operation
- Copper Baseplate and Silicon Nitride Insulator



Applications

- High Frequency Switching Application
- DC/DC Converter
- Solar and Wind Inverters
- UPS and SMPS
- Traction

Ordering Informations

Order Number / Marking	SCE600N1200MA3
Package Type	ME3

Key Parameters

Symbol	Parameter	Values			Unit	Test Conditions
Absolute maximum rating						
V_{DS}	Drain-source Voltage	1200			V	$T_C=25^{\circ}\text{C}$
I_D	Drain Current (continuous)	600			A	$T_C=25^{\circ}\text{C}$
T_J	Junction Temperature	175			$^{\circ}\text{C}$	
Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
Static characteristics						
$R_{DS(on)}$	Static Drain-source on Resistance	-	2.7	3.7	mΩ	$V_{GS}=18\text{V}; I_D=300\text{A}; T_C=25^{\circ}\text{C}$
Dynamic characteristics						
Q_G	Total Gate Charge	-	1428	-	nC	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A}; T_C=25^{\circ}\text{C}$
Q_{GD}	Gate-drain Charge	-	469	-		
Source-drain diode						
Q_{RR}	Reverse Recovery Charge	-	3678	-	nC	$V_{GS}=-5/+18\text{V}; I_F=300\text{A}; V_R=800\text{V}; \text{Load}=100\mu\text{H}; T_J=25^{\circ}\text{C}$

Absolute Maximum Ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Values	Unit
V_{DS}	Drain-source Voltage	1200	V
V_{GS}	Gate-source Voltage (dynamic)	-10/+22	V
I_D	Drain Current (continuous)	600	A
I_{DM}	Drain Current (pulsed)	1200	A
$T_{op}; T_{stg}$	Operating and Storage Temperature Range	-40 to +150	$^\circ\text{C}$
T_J	Junction Temperature	175	$^\circ\text{C}$
$R_{th Jh}$	Thermal Resistance, Junction-to-heatsink	0.12	$^\circ\text{C/W}$

MOSFET Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
Static characteristics (at $T_c=25^\circ\text{C}$ unless otherwise specified)						
BV_{DS}	Drain-source Breakdown Voltage	1200	-	-	V	$V_{GS}=0\text{V}$
I_{DSS}	Zero Gate Voltage Drain Current	-	-	300	μA	$V_{DS}=1200\text{V}; V_{GS}=0\text{V}$
I_{GSS}	Gate-body Leakage Current	-	-	3.0	μA	$V_{GS}=-10/20\text{V}; V_{DS}=0\text{V}$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	-	4.0	V	$V_{DS}=V_{GS}; I_D=60\text{mA}$
$R_{DS(on)}$	Static Drain-source on Resistance	-	2.7	3.7	$\text{m}\Omega$	$V_{GS}=18\text{V}; I_D=300\text{A}$
$V_{GS(on)}$	Recommended Turn-on Voltage	-	18	-	V	Static
$V_{GS(off)}$	Recommended Turn-off Voltage	-	-5	-	V	
R_G	Gate Resistance	-	0.5	-	Ω	$V_{GS}=0\text{V}; f=1\text{MHz}$
Dynamic characteristics (at $T_c=25^\circ\text{C}$ unless otherwise specified)						
C_{iss}	Input Capacitance	-	41.3	-	nF	$V_{DS}=800\text{V}; f=1\text{MHz}; V_{AC}=25\text{mV}$
C_{oss}	Output Capacitance	-	1.7	-		
C_{rss}	Reverse Transfer Capacitance	-	78	-	pF	
E_{on}	Turn-on Switching Energy	-	24.6	-	mJ	$V_{DS}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A};$ $\text{Load}=100\mu\text{H}$
E_{off}	Turn-off Switching Energy	-	19.2	-		
Q_{GS}	Gate-source Charge	-	460	-	nC	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A}$
Q_{GD}	Gate-drain Charge	-	469	-		
Q_G	Total Gate Charge	-	1428	-		
$t_{d(on)}$	Turn-on Delay Time	-	103	-	ns	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A};$ $R_{G(ext)}=5.0\Omega; \text{Load}=100\mu\text{H}$
t_r	Rise Time	-	92	-		
$t_{d(off)}$	Turn-off Delay Time	-	448	-		
t_f	Fall Time	-	76	-		

Body Diode Characteristics (at $T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
V_{FSD}	Forward Voltage	-	-	6	V	$V_{GS}=0\text{V}; I_F=300\text{A}$
I_S	Continuous Diode Forward Current	-	300	-	A	$V_{GS}=0\text{V}; T_C=25^\circ\text{C}$
t_{RR}	Reverse Recovery Time	-	89	-	ns	$V_{GS}=-5/+18\text{V}; I_F=300\text{A}; V_R=800\text{V}; \text{Load}=100\mu\text{H}$
Q_{RR}	Reverse Recovery Charge	-	3678	-	nC	
I_{RRM}	Peak Reverse Recovery Current	-	133	-	A	

Module Physical Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
L_{Stray}	Stray Inductance	-	20	-	nH	
W	Weight	-	340	-	g	
M_S	Mounting Torque	4.0	-	5.5	Nm	M6-1.0 Bolts
V_{isol}	Case Isolation Voltage (DC; $t=1\text{min}$)	4.2	-	-	kV	
-	Clearance Distance	-	11	-	mm	Terminal to Terminal
		-	23	-	mm	Terminal to Baseplate
-	Creepage Distance	-	23	-	mm	Terminal to Terminal
		-	29	-	mm	Terminal to Baseplate

Typical Performance

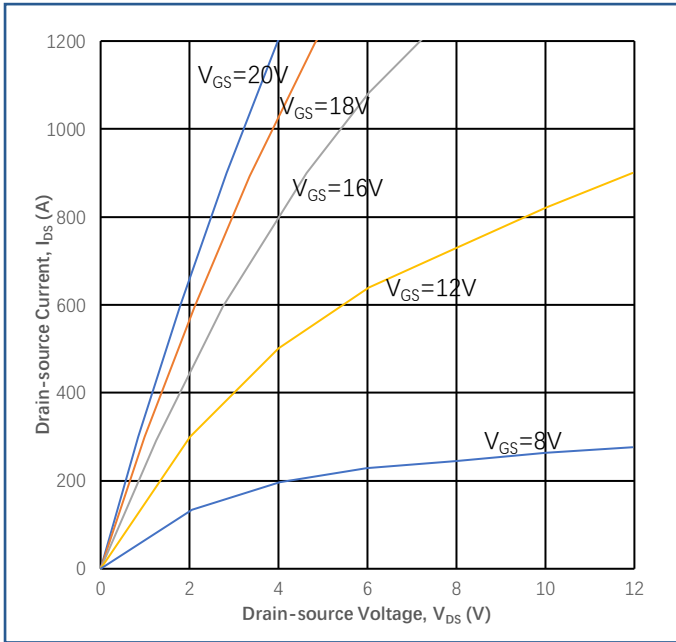


Figure 1
Output Characteristics ($T_J = 25^\circ\text{C}$)

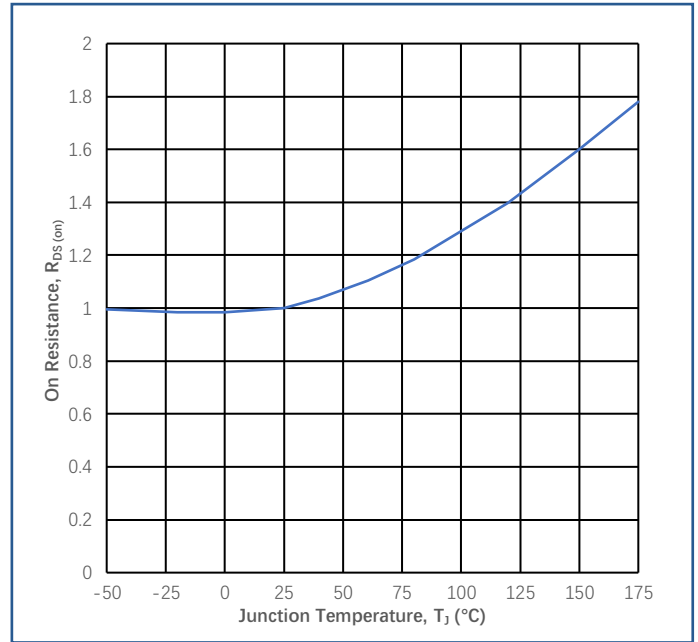


Figure 2
Normalized On-resistance vs. Temperature

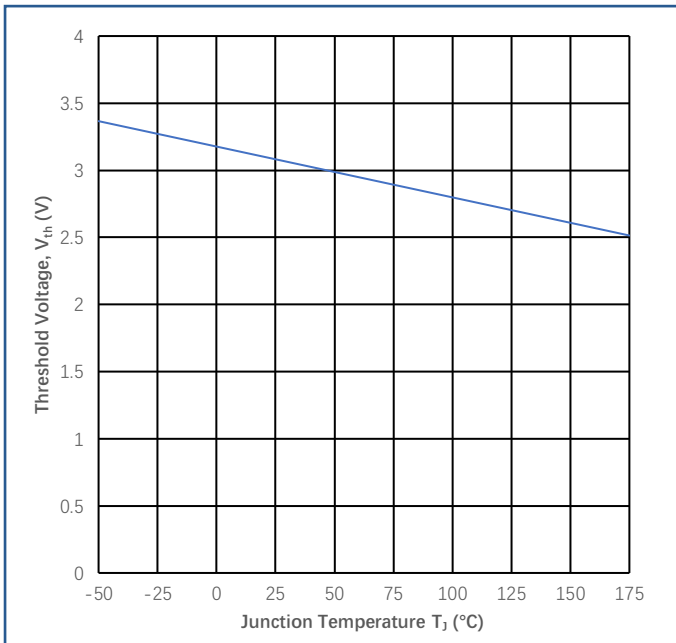


Figure 3
Threshold Voltage vs. Temperature

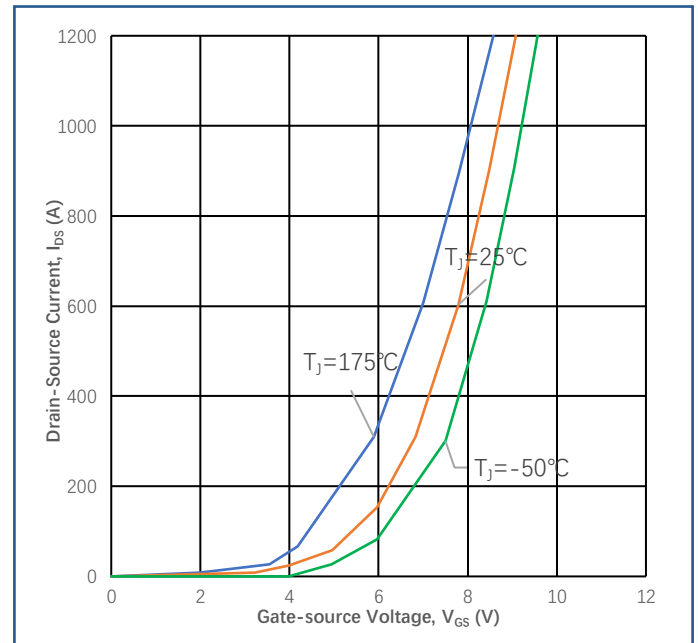


Figure 4
Transfer Characteristic for Various T_J , $V_{DS} = 20\text{V}$

Typical Performance

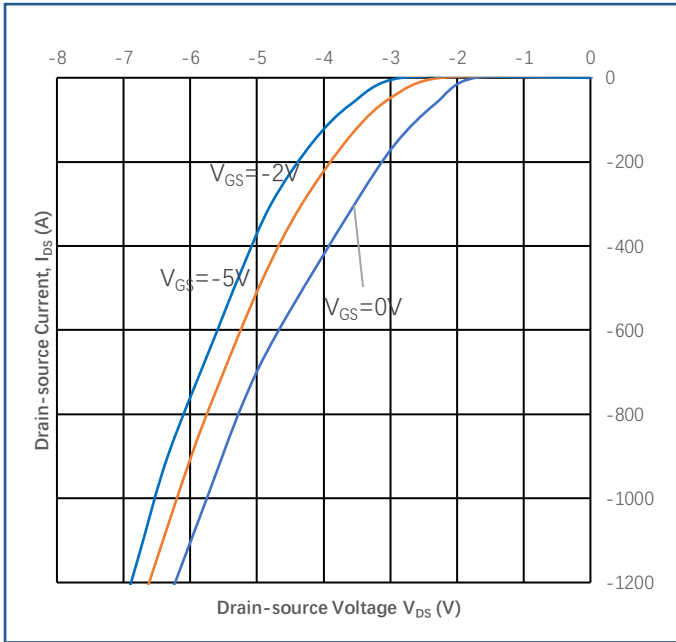


Figure 5
Diode Characteristic at 25 °C

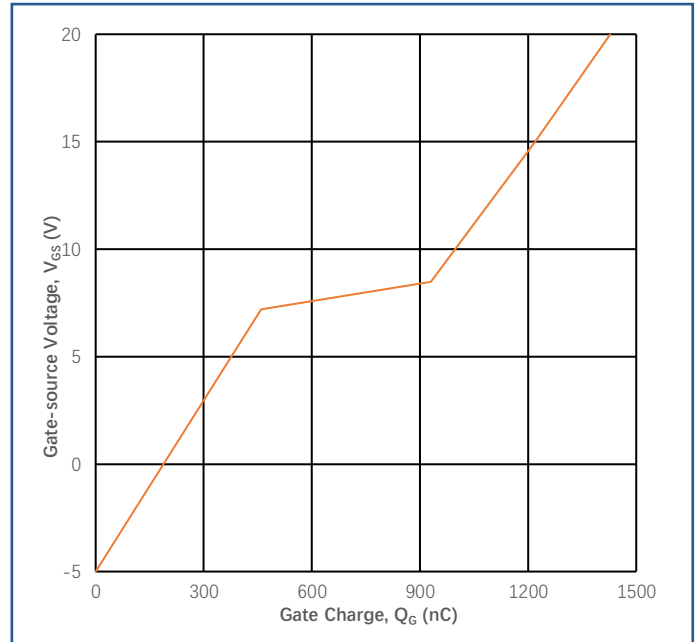


Figure 6
Typical Gate Charge Characteristics

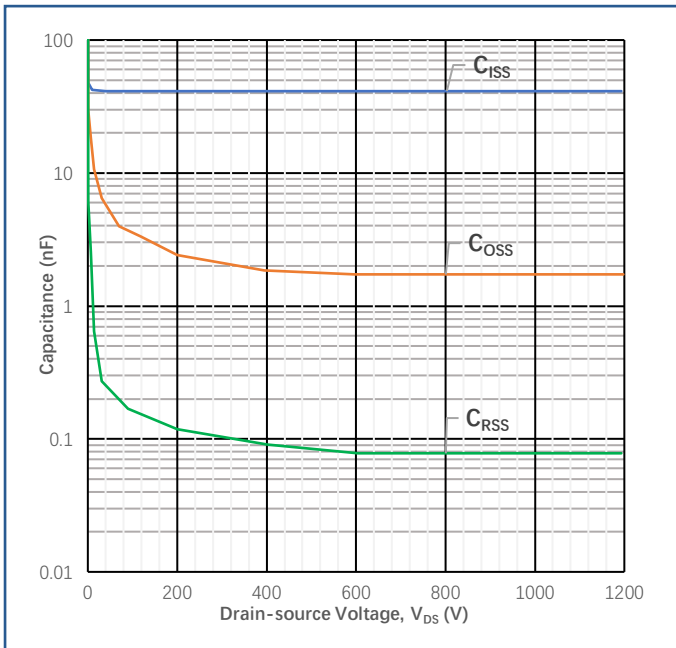


Figure 7
Typical Capacitances vs. Drain-source Voltage

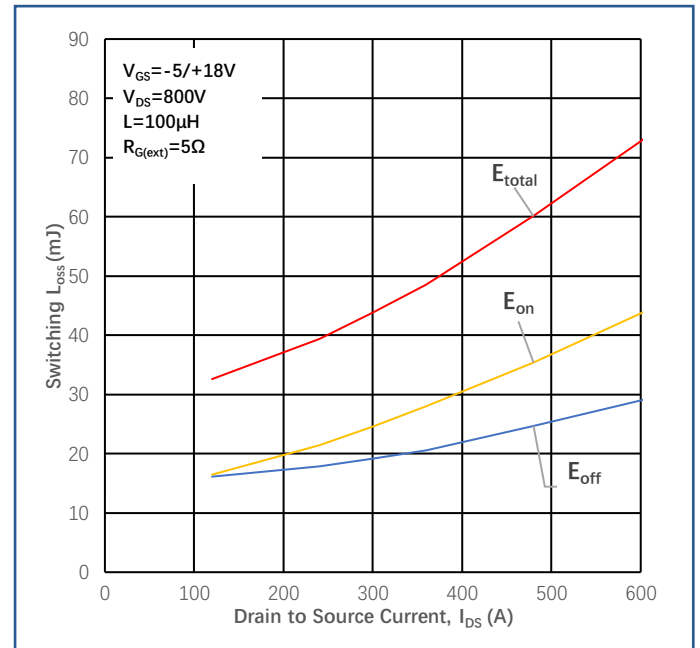


Figure 8
Inductive Switching Energy vs. Drain Current

Typical Performance

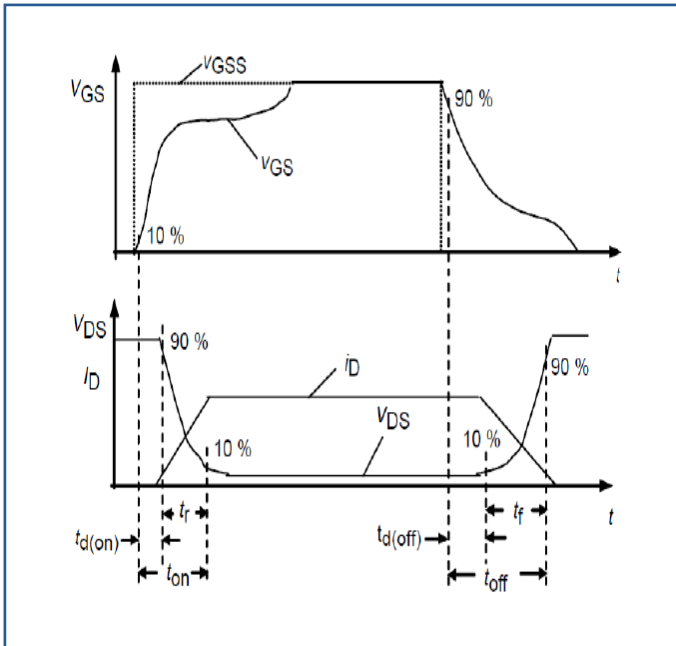


Figure 9
Switching Time Description

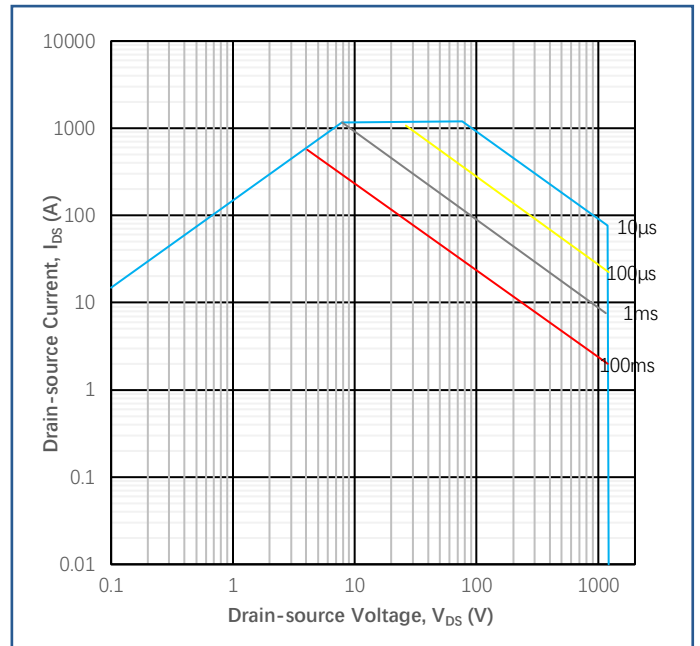
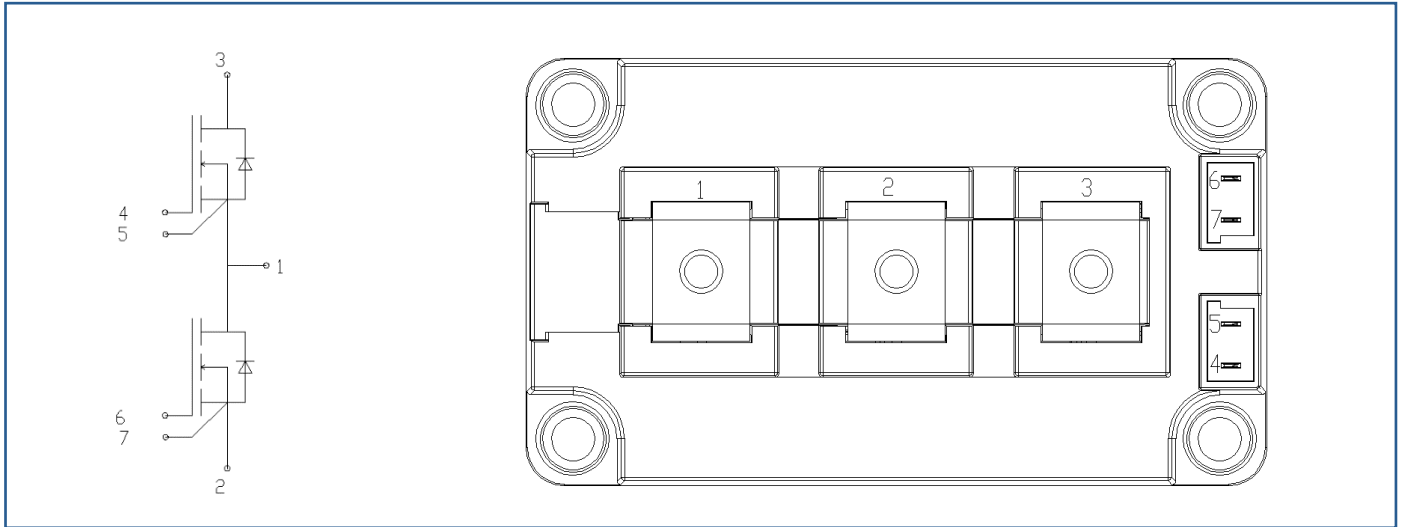
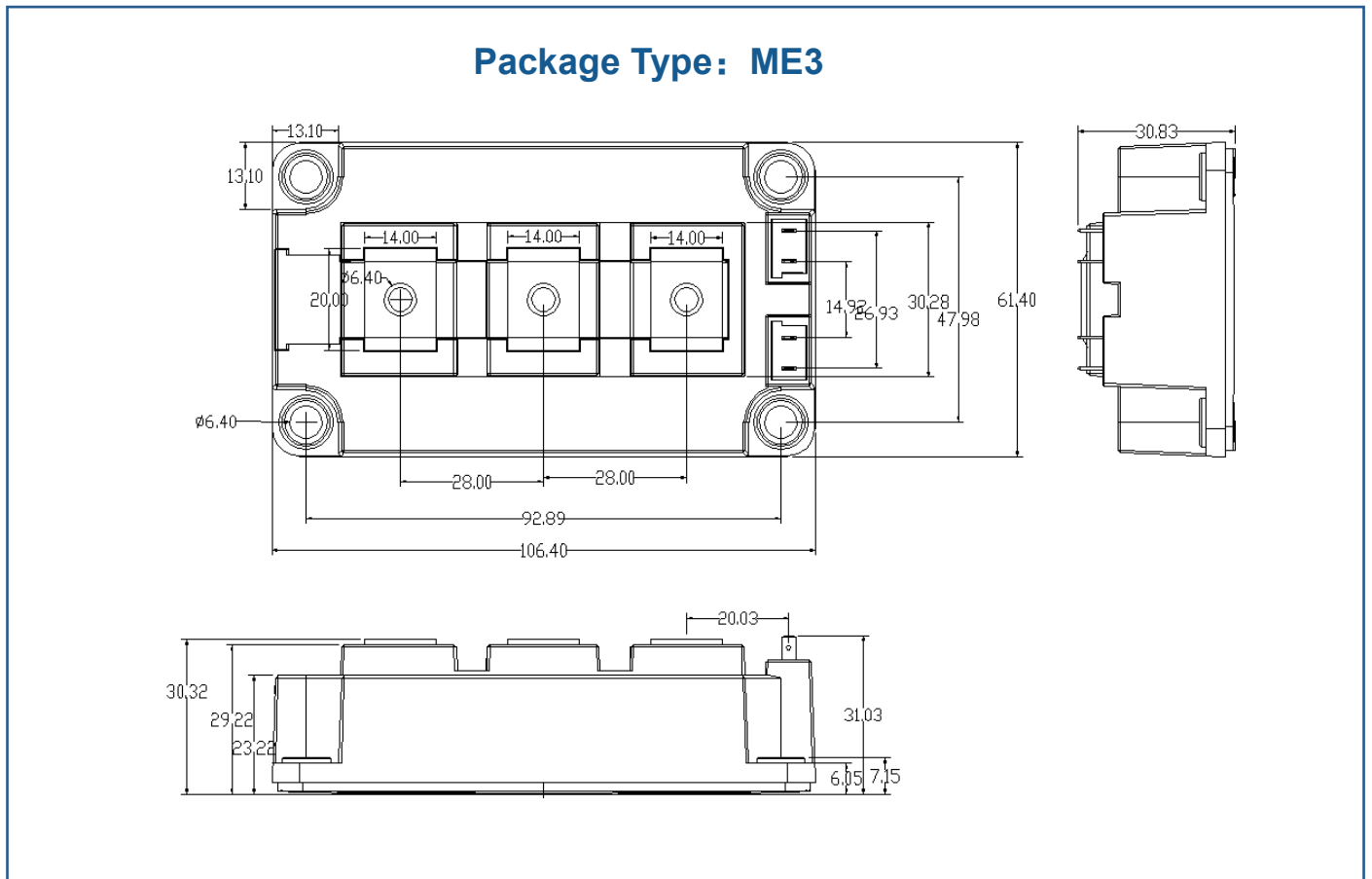


Figure 10
Safe Operating Area

Circuit Diagram Headline



Package Dimensions (mm)



未标注线性公差按 GB/1804-2000c 级执行	公差分段	0.5-3	3-6	6-30	30-120	120-400
	c 级	±0.2	±0.3	±0.5	±0.8	±1.2

Notes & Disclaimer

This document and the information contained herein are subject to change without notice. Any such change shall be evidenced by the publication of an updated version of this document by SCE Technology. No communication from any employee or agent of SCE Technology or any third party shall effect an amendment or modification of this document.

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, SCE Technology hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

Any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of SCE Technology in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Except as otherwise explicitly approved by SCE Technology in a written document signed by authorized representatives, the products of SCE Technology may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.
